

## **PHOTOCOUPLER**

# PS2805-1,PS2805-4

## HIGH ISOLATION VOLTAGE AC INPUT RESPONSE TYPE SSOP PHOTOCOUPLER

-NEPOC Series-

#### **DESCRIPTION**

The PS2805-1 and PS2805-4 are optically coupled isolators containing GaAs light emitting diodes and an NPN silicon phototransistor in a plastic SSOP for high density applications.

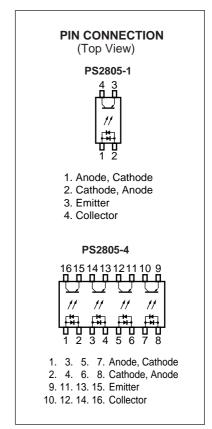
This package has shield effect to cut off ambient light.

#### **FEATURES**

- High isolation voltage (BV = 2 500 Vr.m.s.)
- Small and thin package (4,16-pin SSOP, Pin pitch 1.27 mm)
- High collector to emitter voltage (VcEo = 80 V)
- · AC input response
- High-speed switching ( $t_r = 3 \mu s$  TYP.,  $t_f = 5 \mu s$  TYP.)
- Ordering number of tape product: PS2805-1-F3, F4, PS2805-4-F3, F4
- · Pb-Free product
- Safety standards: PS2805-1, -4
  - UL approved: File No. E72422
  - BSI approved: No. 8188, 8189
  - CSA approved: File No. CA 101391
  - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

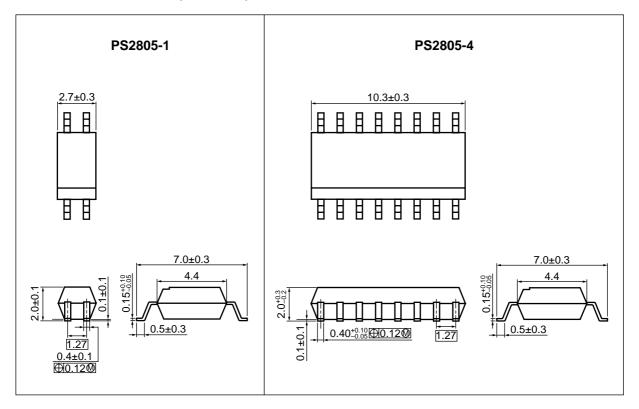
#### **APPLICATIONS**

- Programmable logic controllers
- · Measuring instruments
- Hybrid IC

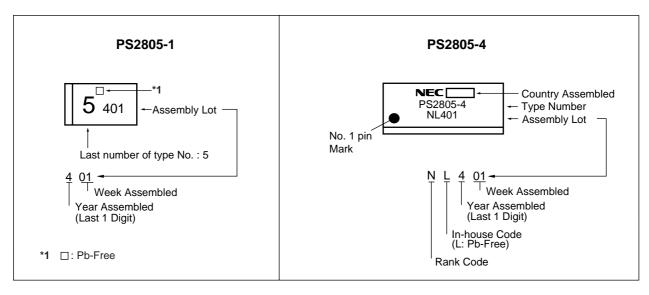


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## PACKAGE DIMENSIONS (UNIT: mm)



## **★ MARKING EXAMPLE**



## **★** ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*
PS2805-1	PS2805-1-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS2805-1
PS2805-1-F3	PS2805-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL, BSI, CSA	
PS2805-1-F4	PS2805-1-F4-A			approved)	
PS2805-1-V	PS2805-1-V-A		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	
PS2805-1-V-F3	PS2805-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2805-1-V-F4	PS2805-1-V-F4-A			Approved (Option)	
PS2805-4	PS2805-4-A		Magazine Case 45 pcs	Standard products	PS2805-4
PS2805-4-F3	PS2805-4-F3-A		Embossed Tape 2 500 pcs/reel	(UL, BSI, CSA	
PS2805-4-F4	PS2805-4-F4-A			approved)	
PS2805-4-V	PS2805-4-V-A		Magazine Case 45 pcs	DIN EN60747-5-2	
PS2805-4-V-F3	PS2805-4-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS2805-4-V-F4	PS2805-4-V-F4-A			Approved (Option)	

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (Unless otherwise specified, T<sub>A</sub> = 25°C)

Parameter		Symbol	Ratings		Unit
			PS2805-1	PS2805-4	
Diode	Forward Current (DC)	lF	± <b>!</b>	mA/ch	
	Power Dissipation Derating	⊿P <sub>D</sub> /°C	0.6	0.8	mW/°C
	Power Dissipation	P□	60	80	mW/ch
	Peak Forward Current*1	IFP	±1		A/ch
Transistor	Collector to Emitter Voltage	VCEO	80		٧
	Emitter to Collector Voltage	VECO	6	3	V
	Collector Current	Ic	5	0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1.	2	mW/°C
	Power Dissipation	Pc	12	20	mW/ch
Isolation Voltage*2		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100		°C
Storage Temperature		Tstg	-55 to +150		°C

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1%

<sup>\*2</sup> AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output.

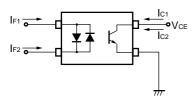
Pins 1-2 shorted together, 3-4 shorted together (PS2805-1).

Pins 1-8 shorted together, 9-16 shorted together (PS2805-4).

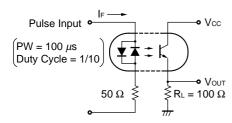
## **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	$I_F = \pm 5 \text{ mA}$		1.1	1.4	V
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		30		pF
Transistor	Collector to Emitter Dark Current	ICEO	Vce = 80 V, I <sub>F</sub> = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/I <sub>F</sub> )	CTR	$I_F = \pm 5$ mA, $V_{CE} = 5$ V	80		600	%
	CTR Ratio*1	CTR1/ CTR2	I <sub>F</sub> = 5 mA, V <sub>CE</sub> = 5 V	0.3	1.0	3.0	
	Collector Saturation Voltage	VCE(sat)	I <sub>F</sub> = ±10 mA, I <sub>C</sub> = 2 mA			0.3	V
	Isolation Resistance	R <sub>I-O</sub>	Vi-o = 1.0 kVpc	10 <sup>11</sup>			Ω
	Isolation Capacitance	Cı-o	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time *2	<b>t</b> r	$Vcc = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$		3		μS
	Fall Time *2	<b>t</b> f			5		

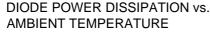
\*1 CTR1 = Ic1/IF1, CTR2 = Ic2/IF2

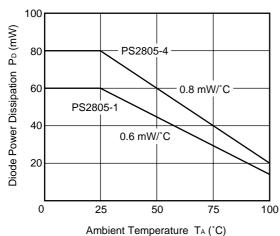


\*2 Test circuit for switching time



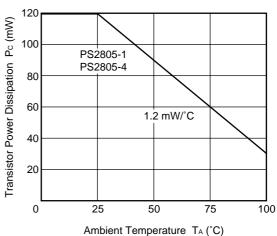
## TYPICAL CHARACTERISTICS (Unless otherwise specified, TA = 25°C)



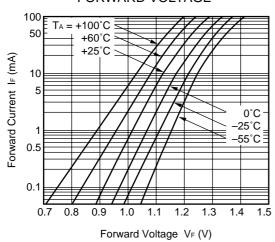


## vs. AMBIENT TEMPERATURE

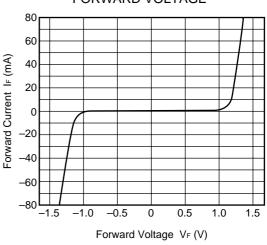
TRANSISTOR POWER DISSIPATION



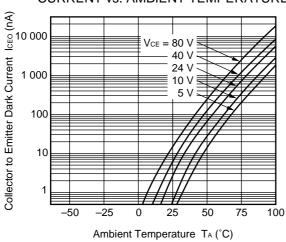
## FORWARD CURRENT vs. FORWARD VOLTAGE



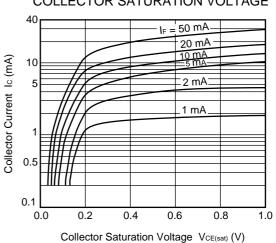
FORWARD CURRENT vs. FORWARD VOLTAGE



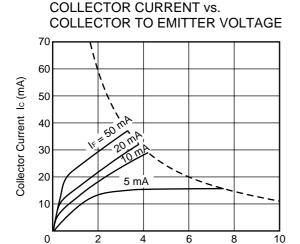
## COLLECTOR TO EMITTER DARK **CURRENT vs. AMBIENT TEMPERATURE**



COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE** 

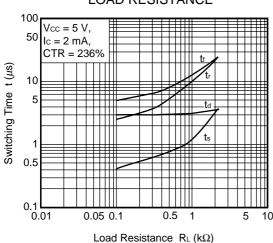


Remark The graphs indicate nominal characteristics.

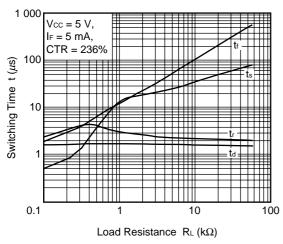


## SWITCHING TIME vs. LOAD RESISTANCE

Collector to Emitter Voltage VcE (V)

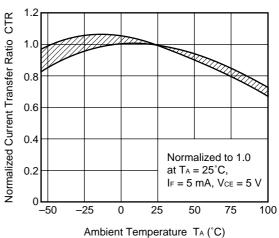


## SWITCHING TIME vs. LOAD RESISTANCE

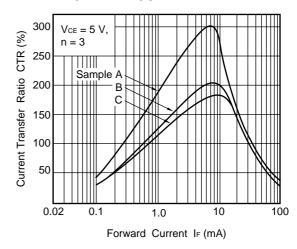


Remark The graphs indicate nominal characteristics.

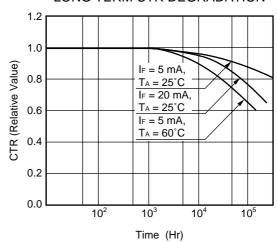
## NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



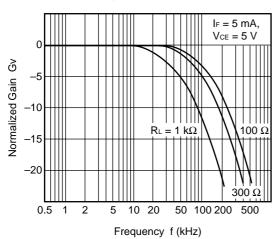
## CURRENT TRANSFER RATIO vs. FORWARD CURRENT



## LONG TERM CTR DEGRADATION

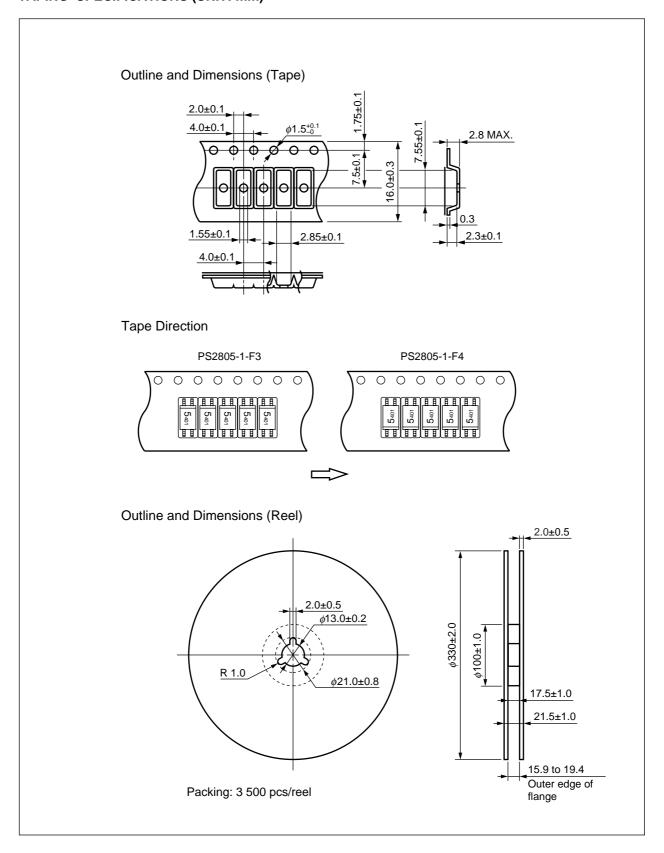


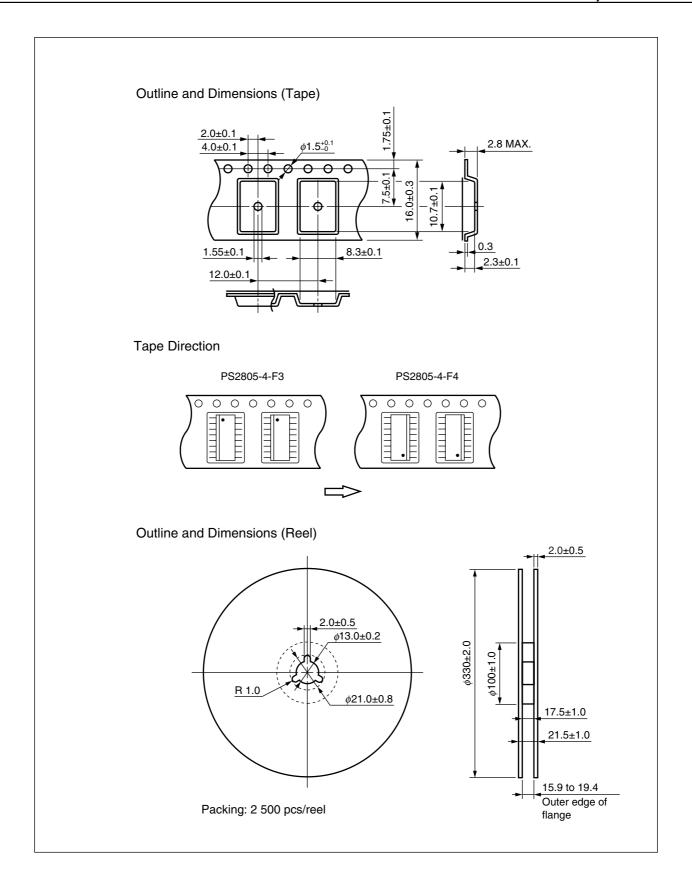
## FREQUENCY RESPONSE



**Remark** The graph indicates nominal characteristics.

## TAPING SPECIFICATIONS (UNIT: mm)





#### NOTES ON HANDLING

### 1. Recommended soldering conditions

## (1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

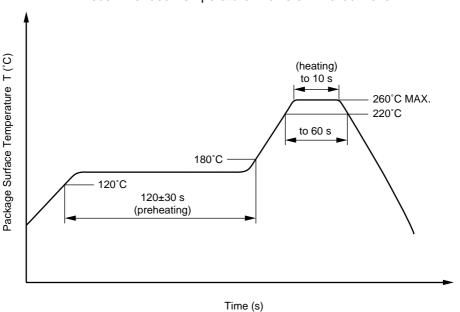
Time of peak reflow temperature
 Time of temperature higher than 220°C
 60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
 Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

## Recommended Temperature Profile of Infrared Reflow



## (2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

Preheating conditions
 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Flux
 Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

### (3) Soldering by soldering iron

Peak temperature (lead part temperature) 350°C or below
 Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

## 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

## ★ 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below I<sub>F</sub> = 1 mA.

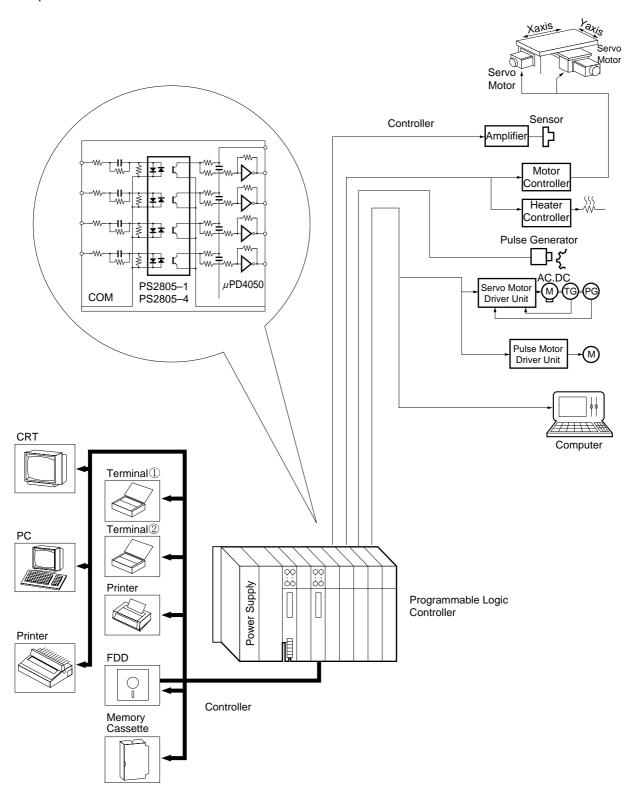
Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

## **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

## PROGRAMMABLE LOGIC CONTROLLERS EXAMPLE

Purpose: In-out interface



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M8E 00.4-0110

#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

### ▶For further information, please contact

## NEC Compound Semiconductor Devices, Ltd. http://www.ncsd.necel.com/

E-mail: salesinfo@ml.ncsd.necel.com (sales and general) techinfo@ml.ncsd.necel.com (technical)

Sales Division TEL: +81-44-435-1573 FAX: +81-44-435-1579

#### **NEC Compound Semiconductor Devices Hong Kong Limited**

E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)

Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309
Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859
Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

#### NEC Electronics (Europe) GmbH http://www.ee.nec.de/

TEL: +49-211-6503-0 FAX: +49-211-6503-1327

#### California Eastern Laboratories, Inc. http://www.cel.com/

TEL: +1-408-988-3500 FAX: +1-408-988-0279